

1. Features

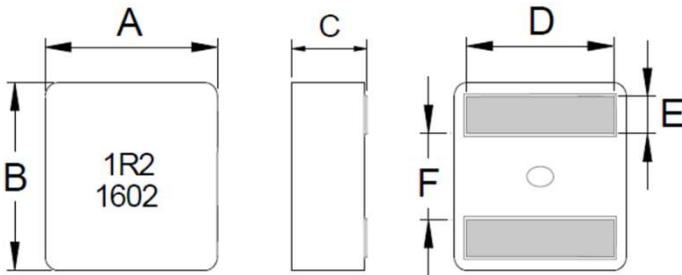
1. Soft saturation.
2. High current + low DCR + high efficiency.
3. Very low acoustic noise and very low leakage flux noise.
4. High reliability.
5. 100% Lead(Pb)-Free and RoHS compliant.



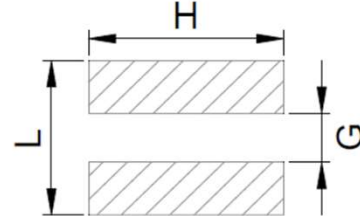
2. Applications

Note PC power system + incl. IMVP-6
DC/DC converter .

3. Dimensions



Recommend PC Board Pattern



L(mm)	G(mm)	H(mm)
5.6 ref	2.5 ref	5.6 ref

Note: 1、 The above PCB layout reference only.
2、 Recommend solder paste thickness at 0.15mm and above.

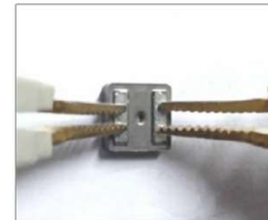
Series	Inductance Range	A (mm)	B (mm)	C (mm)	D (mm)	E (mm)	F (mm)
TMPF0603A	1.2uH and below	6.6±0.2	6.4±0.2	2.8±0.2	See Spec table	1.4±0.2	2.6±0.25
	1.5uH and above			2.9±0.2			

4. Part Numbering

TMPF **0603** **A** - **1R2** **MN** - **D**
A B C D E F

A: Series
B: Dimension
C: Type
D: Inductance
E: Inductance Tolerance
F: Code

BxC
Material.
1R2=1.20uH
M=±20%
Marking: Black:1R2 and 1602(16 YY, 02 WW, follow production date).



DCR Test

5. Specification

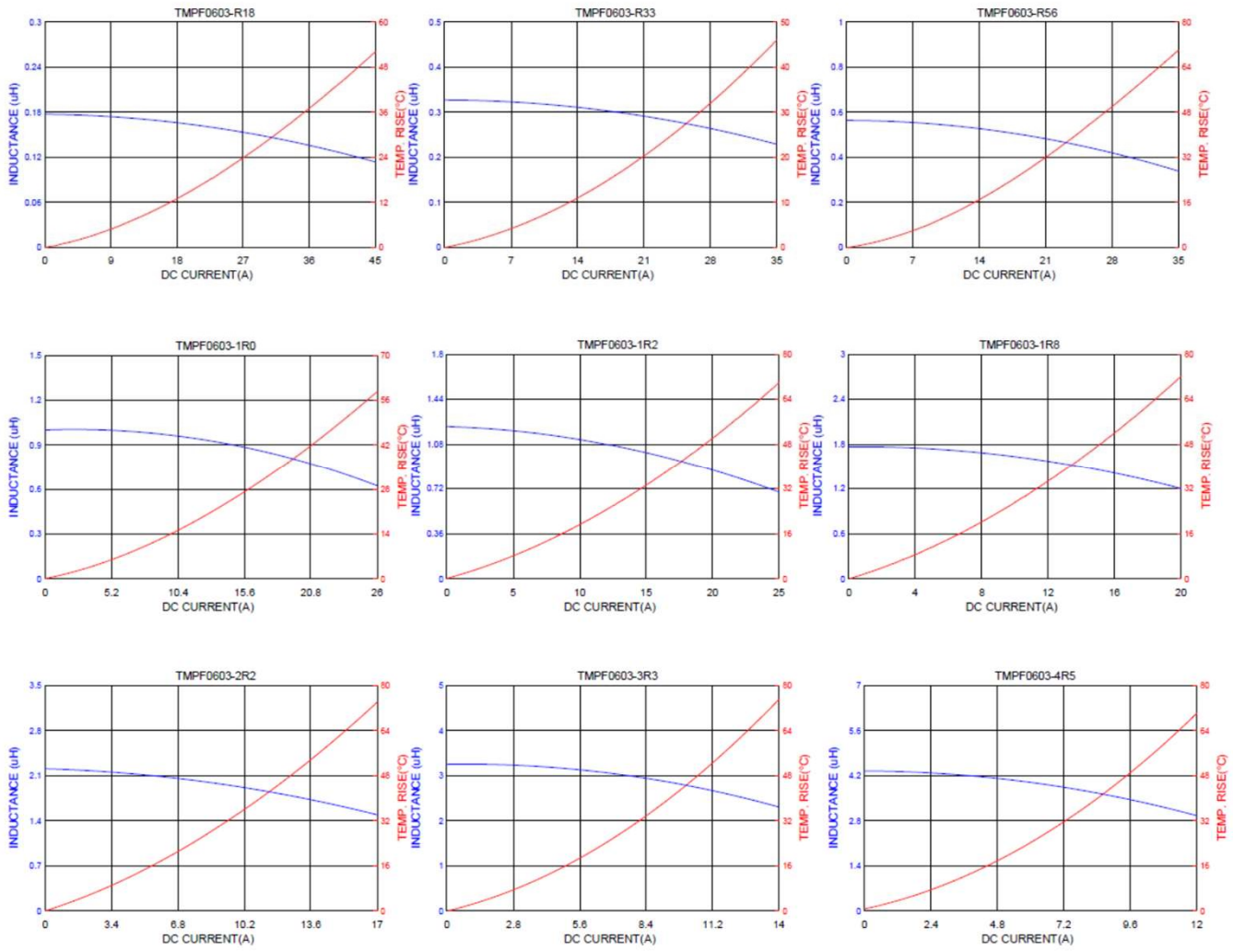
Part Number	Inductance(uH) ±20% @ 0 A	I rms(A) Typ		I sat(A)		DCR (mΩ) Typ.	DCR (mΩ) Max.	D(mm) ±0.3
		20°C rise	40°C rise	Typ	Max			
TMPF0603A-R18MN-D	0.18	24.0	32.0	40.0	36.0	1.60	1.75	5.30
TMPF0603A-R33MN-D	0.33	20.0	25.0	32.0	28.0	2.25	2.50	5.55
TMPF0603A-R56MN-D	0.56	17.0	22.0	29.0	25.0	3.00	3.31	5.30
TMPF0603A-1R0MN-D	1.00	13.0	18.0	23.0	18.0	5.50	6.05	5.20
TMPF0603A-1R2MN-D	1.20	12.0	16.0	22.0	16.0	6.70	7.40	5.15
TMPF0603A-1R8MN-D	1.80	10.0	14.0	18.2	13.0	9.20	10.2	5.10
TMPF0603A-2R2MN-D	2.20	7.00	10.0	15.9	11.0	11.0	12.2	5.05
TMPF0603A-3R3MN-D	3.30	6.00	8.00	12.2	9.00	18.8	20.8	5.00
TMPF0603A-4R5MN-D	4.50	5.00	7.00	10.0	8.00	23.0	25.3	5.00

Note:

1. Test frequency : L : 100KHz /0.1V.
2. All test data referenced to 25°C ambient.
3. Testing Instrument : L: HP4284A,HP4395A,CH11025,CH3302,CH1320 ,CH1320S LCR METER / Rdc:CH16502,Agilent33420A MICRO OHMMETER,or EQU.
4. Current that causes the specified temperature rise from 25°C ambient.
5. Saturation Current (Isat) will cause L0 to drop approximately 30%.
6. The part temperature (ambient + temp rise) should not exceed 125°C under worst case operating conditions.Circuit design,component,PCB trace size and thickness,airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.
7. Special inquiries besides the above common used types can be met on your requirement.

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6. Typical Performance Curves



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